

December 2014

FCU4300N80Z

N-Channel SuperFET® II MOSFET

800 V, 1.6 A, 4.3 Ω

Features

- $R_{DS(on)} = 3.4 \Omega (Typ.)$
- Ultra Low Gate Charge (Typ. Q_q = 6.8 nC)
- Low E_{oss} (Typ. 0.8 uJ @ 400V)
- Low Effective Output Capacitance (Typ. C_{oss(eff.)} = 36 pF)
- · 100% Avalanche Tested
- · RoHS Compliant
- · ESD Improved Capability

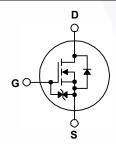
Applications

- · AC DC Power Supply
- · LED Lighting

Description

SuperFET® II MOSFET is Fairchild Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. In addition, internal gate-source ESD diode allows to withstand over 2kV HBM surge stress. Consequently, SuperFET II MOSFET is very suitable for the switching power applications such as Audio, Laptop adapter, Lighting, ATX power and industrial power applications.





Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol			FCU4300N80Z	Unit	
V _{DSS}	Drain to Source Voltage		800	V	
V	Cata to Course Valtage	- DC	/	±20	V
V_{GSS}	Gate to Source Voltage	- AC	(f > 1 Hz)	±30	V
	Drain Current	- Continuous (T _C = 25°C)		1.6	А
I _D	Diam Current	- Continuous (T _C = 100°C)		1.0	
I _{DM}	Drain Current	- Pulsed	(Note 1)	3.2	Α
E _{AS}	Single Pulsed Avalanche Energy	Single Pulsed Avalanche Energy (Note 2)			
I _{AR}	Avalanche Current	0.32	Α		
E _{AR}	Repetitive Avalanche Energy		(Note 1)	0.28	mJ
dv/dt	MOSFET dv/dt	100	V/ns		
dv/dt	Peak Diode Recovery dv/dt	20			
D	Davies Dissination	$(T_C = 25^{\circ}C)$		27.8	W
P_{D}	Power Dissipation	0.22	W/°C		
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to +150	οС
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds			300	°С

Thermal Characteristics

Symbol	Parameter FCU4300N80Z					
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max. 4.5					
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max. 100					

Package Marking and Ordering Information

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FCU4300N80Z	FCU430080Z	IPAK	Tube	N/A	N/A	75 units

Electrical Characteristics $T_C = 25^{\circ}C$ unless otherwise noted.

Symbol	Parameter	lest Conditions	Wiin.	ıyp.	wax.	Unit
Off Chara	cteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_D = 1 \text{ mA}, T_J = 25^{\circ}\text{C}$	800	-	-	V
ΔBV _{DSS} / ΔT _J	Breakdown Voltage Temperature Coefficient	I _D = 1 mA, Referenced to 25°C	-	0.85	-	V/°C
I _{DSS} Z	Zero Gate Voltage Drain Current	$V_{DS} = 800 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	25	μА
	Zero Gate Voltage Drain Current	$V_{DS} = 640 \text{ V}, V_{GS} = 0 \text{ V}, T_{C} = 125^{\circ}\text{C}$	-	-	250	μΑ
I _{GSS}	Gate to Body Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$	-	-	±10	μΑ

On Characteristics

V _{GS(th)}	Gate Threshold Voltage	$V_{GS} = V_{DS}$, $I_{D} = 0.16$ mA	2.5	-	4.5	V
R _{DS(on)}	Static Drain to Source On Resistance	$V_{GS} = 10 \text{ V}, I_D = 0.8 \text{ A}$	-	3.4	4.3	Ω
9 _{FS}	Forward Transconductance	$V_{DS} = 20 \text{ V}, I_{D} = 0.8 \text{ A}$	-	0.52	-	S

Dynamic Characteristics

C _{iss}	Input Capacitance	400 4 4 4 0 4	-\	267	355	pF
C _{oss}	Output Capacitance	V _{DS} = 100 V, V _{GS} = 0 V, f = 1 MHz	- \	12	16	pF
C _{rss}	Reverse Transfer Capacitance	1 - 1 WI 12	-	0.78	-	pF
C _{oss}	Output Capacitance	$V_{DS} = 480 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	6.2	-	pF
C _{oss(eff.)}	Effective Output Capacitance	$V_{DS} = 0 \text{ V to } 480 \text{ V}, V_{GS} = 0 \text{ V}$	-	36	-	pF
Q _{g(tot)}	Total Gate Charge at 10V	V _{DS} = 640 V, I _D = 1.6 A,	-	6.8	8.8	nC
Q_{gs}	Gate to Source Gate Charge	V _{GS} = 10 V	-	1.38	-	nC
Q _{gd}	Gate to Drain "Miller" Charge	(Note 4)	-	3.0	-	nC
ESR	Equivalent Series Resistance	f = 1 MHz	-	2.9	-	Ω

Switching Characteristics

	_						
t _{d(on)}	Turn-On Delay Time			-	10	30	ns
t _r	Turn-On Rise Time	$V_{DD} = 400 \text{ V}, I_D = 1.6 \text{ A},$		-	6.5	23	ns
t _{d(off)}	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, R_g = 4.7 \Omega$		- /	21	52	ns
t _f	Turn-Off Fall Time		(Note 4)	-	16	42	ns

Drain-Source Diode Characteristics

Is	Maximum Continuous Drain to Source Diode Forward Current	-	-	1.6	Α
I _{SM}	Maximum Pulsed Drain to Source Diode Forward Current	-	-	3.2	Α
V_{SD}	Drain to Source Diode Forward Voltage V _{GS} = 0 V, I _{SD} = 1.6 A	-	-	1.2	V
t _{rr}	Reverse Recovery Time $V_{GS} = 0 \text{ V}, I_{SD} = 1.6 \text{ A},$	-	209	-	ns
Q _{rr}	Reverse Recovery Charge $dI_F/dt = 100 \text{ A/}\mu\text{s}$	-	1.2	-//	μС

Notes:

- 1. Repetitive rating: pulse width limited by maximum junction temperature.
- 2. I $_{AS}$ = 0.32 A, R $_{G}$ = 25 Ω , starting T $_{J}$ = 25°C
- 3. I $_{SD} \leq$ 1.6 A, di/dt \leq 200 A/µs, V $_{DD} \leq$ BV $_{DSS}$, starting T $_{J}$ = 25°C
- 4. Essentially independent of operating temperature typical characteristic.

Typical Performance Characteristics

Figure 1. On-Region Characteristics

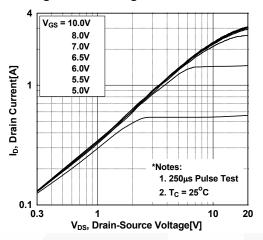


Figure 3. On-Resistance Variation vs.

Drain Current and Gate Voltage

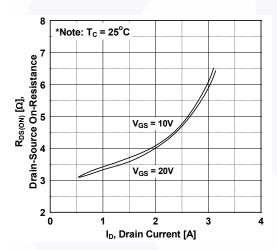


Figure 5. Capacitance Characteristics

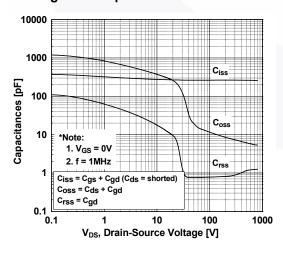


Figure 2. Transfer Characteristics

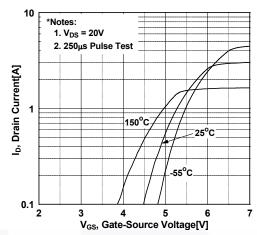


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

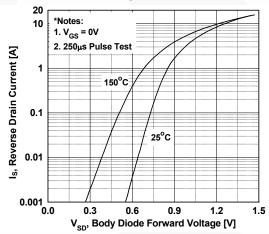
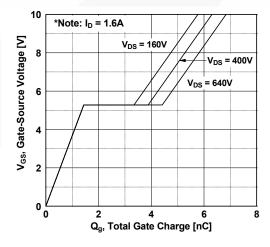


Figure 6. Gate Charge Characteristics



Typical Performance Characteristics (Continued)

Figure 7. Breakdown Voltage Variation vs. Temperature

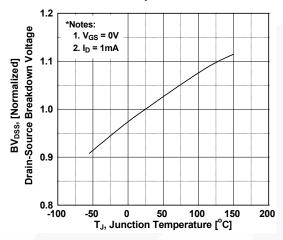


Figure 9. Maximum Safe Operating Area

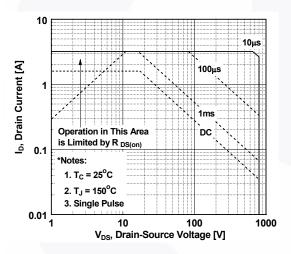


Figure 11. Eoss vs. Drain to Source Voltage

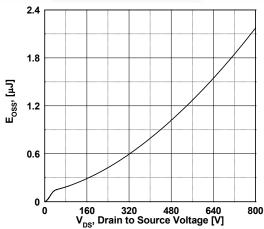


Figure 8. On-Resistance Variation vs. Temperature

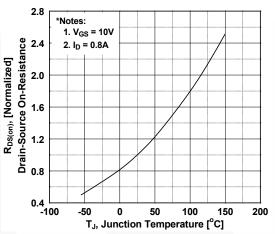
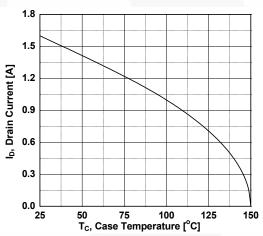
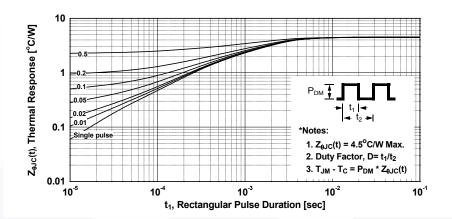


Figure 10. Maximum Drain Current vs. Case Temperature



Typical Performance Characteristics (Continued)

Figure 12. Transient Thermal Response Curve



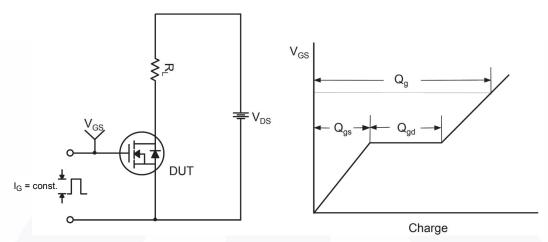


Figure 13. Gate Charge Test Circuit & Waveform

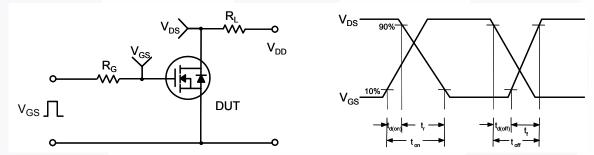


Figure 14. Resistive Switching Test Circuit & Waveforms

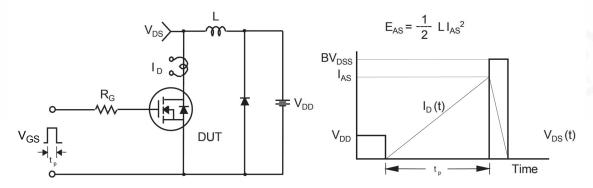


Figure 15. Unclamped Inductive Switching Test Circuit & Waveforms

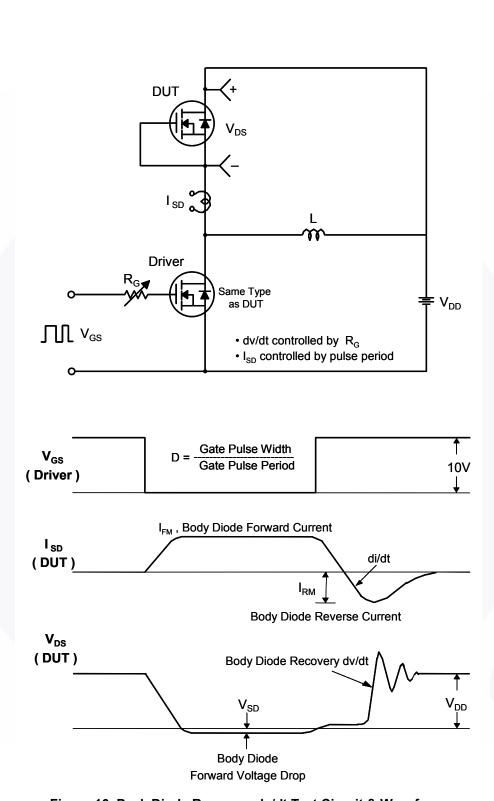
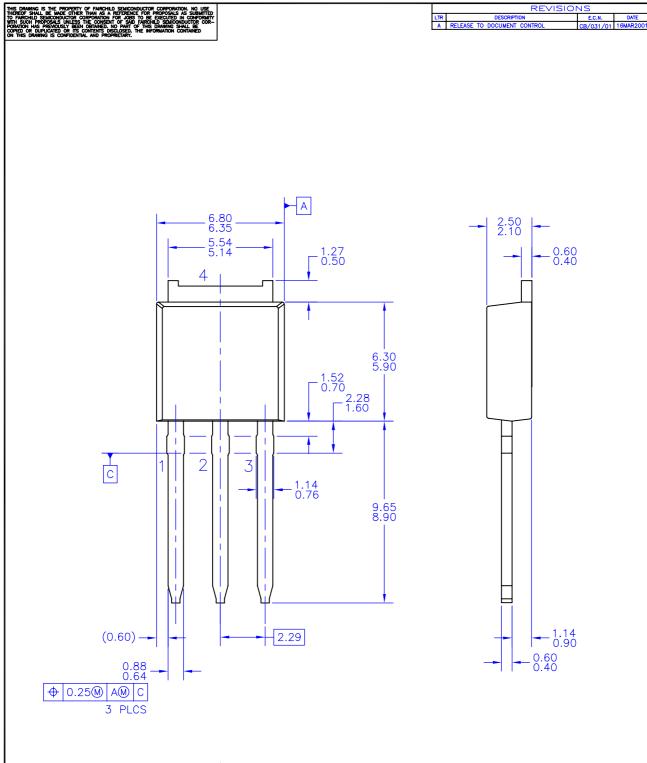
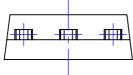


Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms





NOTES: UNLESS OTHERWISE SPECIFIED

- A) ALL DIMENSIONS ARE IN MILLIMETERS.
- B) THIS PACKAGE CONFORMS TO JEDEC, TO-251, ISSUE C, VARIATION AA, DATED SEP 1988.
- C) DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.

APPROVALS	DATE					
DRAWN: J. GOMEZ	16MAR2001	FAIF	2 C	HILD	CEBU PHILIPPINE	FC
CHECKED: R. MANABIT		SEMIC		DUCTOF	THILIFFING	
APPROVED: M. GESTOLE		TO-2	251	(I-PAI	K) MOLDED),
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